

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Junichi HAGIHARA

Application No.: 10/562,923

Filed: December 30, 2005

For: WIRING BOARD MEMBER FOR
FORMING MULTILAYER WIRING BOARD,
METHOD OF MANUFACTURING THE
SAME, AND MULTILAYER WIRING BOARD
(AS AMENDED)

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) Group Art Unit: **Not Yet Assigned**

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) Examiner: **Not Yet Assigned**
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**Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

MAIL BOX MISSING PARTS

Sir:

SUBMISSION OF ENGLISH LANGUAGE TRANSLATION OF APPLICATION

Enclosed is the literal translation of the above-identified application which was filed on December 30, 2005, in accordance with §608.01 of the MPEP, Filing of Non-English Language Applications. Also enclosed is a verification by the translator testifying to the accuracy of the translation.

Please associate this translation with the application as filed on December 30, 2005, and assigned serial number 10/562,923.

Also enclosed is a check for \$130.00 for the English-language translation surcharge. Please grant any extensions of time required to enter this statement.

Authorization is hereby given to charge any additional fees associated
with this matter to our deposit account no. 06-0916.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW,
GARRETT & DUNNER, L.L.P.

Dated: March 31, 2008

By:



David W. Hill
Reg. No. 28,220

Enclosures
DWH/FPD/rac

ERNEST F. CHAPMAN
Reg. No. 25,961

D E C L A R A T I O N

In the matter of the Application
for Patent in U.S.A. in the name
of Junichi HAGIHARA.


I, Hiroshi NAGAI, of Kyowa Patent and Law Office, 2-3,
Marunouchi 3-Chome, Chiyoda-Ku, Tokyo-To, Japan, declare
and say:

that I am thoroughly conversant with both the Japanese
and English languages; and,

that the attached document represents a true English
translation of PCT/JP2004/009150 filed on June 29, 2004.

I further declare that all statements made herein of
my own knowledge are true and that all statements made on
information and belief are believed to be true; and further
that these statements were made with the knowledge that
willful false statements and the like so made are punishable
by fine or imprisonment, or both, under Section 1001 of Title
18 of the United States Code, and that such willful false
statements may jeopardize the validity of the application
or any patent issued thereon.

Dated: November 20, 2007



Hiroshi NAGAI